#### **Features**

- Single Voltage Operation
  - 5V Read
  - 5V Programming
- Fast Read Access Time 55 ns
- Internal Erase/Program Control
- Sector Architecture
  - One 8K Words (16K bytes) Boot Block with Programming Lockout
  - Two 4K Words (8K bytes) Parameter Blocks
  - One 240K Words (480K bytes) Main Memory Array Block
- Fast Sector Erase Time 10 seconds
- Byte-by-Byte or Word-By-Word Programming 10 μs Typical
- Hardware Data Protection
- DATA Polling For End Of Program Detection
- Low-Power Dissipation
  - 50 mA Active Current
  - 300 μA CMOS Standby Current
- Typical 10,000 Write Cycles

#### **Description**

The AT49F004(T) and AT49F4096A(T) are 5-volt, 4-megabit Flash Memories organized as 524,288 words of 8 bits each or 256K words of 16 bits each. Manufactured with Atmel's advanced nonvolatile CMOS technology, the devices offer access times to 55 ns with power dissipation of just 275 mW. When deselected, the CMOS standby current is less than 300  $\mu$ A.

The device contains a user-enabled "boot block" protection feature. Two versions of the feature are available: the AT49F004/4096A locates the boot block at lowest order addresses ("bottom boot"); the AT49F004T/4096AT locates it at highest order addresses ("top boot").

To allow for simple in-system reprogrammability, the AT49F004(T)/4096A(T) does not require high input voltages for programming. Reading data out of the device is similar to reading from an EPROM; it has standard  $\overline{\text{CE}}$ ,  $\overline{\text{OE}}$ , and  $\overline{\text{WE}}$  inputs to avoid bus contention. Reprogramming the AT49F004(T)/4096A(T) is performed by first erasing a

(continued)

### **Pin Configurations**

Pin Name	Function
A0 - A18	Addresses
CE	Chip Enable
ŌĒ	Output Enable
WE	Write Enable
RESET	Reset
RDY/BUSY	Ready/Busy Output
I/O0 - I/O14	Data Inputs/Outputs
I/O15(A-1)	I/O15 (Data Input/Output, Word Mode) A-1 (LSB Address Input, Byte Mode)
BYTE	Selects Byte or Word Mode
NC	No Connect



4-Megabit (512K x 8/ 256K x 16) CMOS Flash Memory

AT49F004 AT49F004T AT49F4096A AT49F4096AT Preliminary

Rev. 1167A-09/98

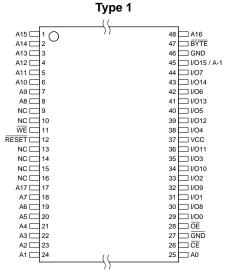




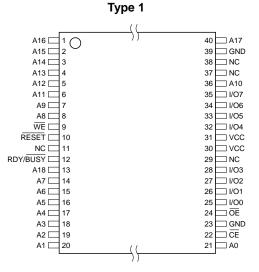
AT49F4096A(T) SOIC (SOP)

#### 44 RESET NC 🗀 NC □ 43 □ WE A17 🗀 42 □ A8 A7 □ \_\_\_ A9 40 A10 A6 □ A5 □ 6 39 \_\_ A11 ☐ A12 A4 □ 38 \_\_\_ A13 A3 🗆 8 37 A2 🗆 36 ☐ A14 \_\_\_ A15 10 A1 [ 35 A0 🗆 11 34 A16 BYTE CF [ 12 33 GND [ 13 32 GND OE [ 31 □ I/O15/A-1 □ I/O7 I/O0 [ 15 30 I/O8 [ 16 29 1/014 28 I/O1 □ □ I/O6 27 I/O9 [ I/O13 I/O2 [ □ I/O5 19 26 I/O10 🗀 20 25 I/O12 I/O3 [ I/O4

AT49F4096A(T) TSOP Top View



AT49F004(T) TSOP Top View



block of data and then programming on a byte-by-byte or word-by-word basis.

The device is erased by executing the erase command sequence; the device internally controls the erase operation. The memory is divided into four blocks for erase operations. There are two 4K word parameter block sections, the boot block, and the main memory array block. The typical number of program and erase cycles is in excess of 10,000 cycles.

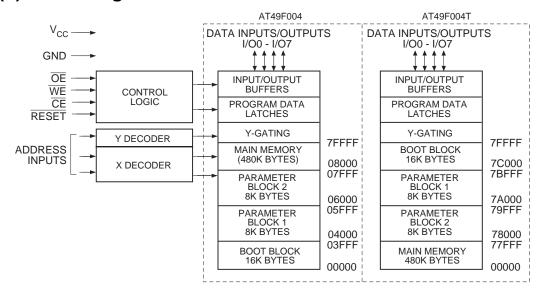
The 8K word boot block section includes a reprogramming lock out feature to provide data integrity. This feature is enabled by a command sequence. Once the boot block programming lockout feature is enabled, the data in the

boot block cannot be changed when input levels of 5.5 volts or less are used. The boot sector is designed to contain user secure code.

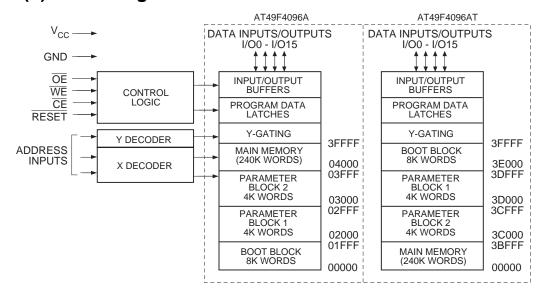
For the AT49F4096A(T), the  $\overline{BYTE}$  pin controls whether the device data I/O pins operate in the byte or word configuration. If the  $\overline{BYTE}$  pin is set at a logic "1" or left open, the device is in word configuration, I/O0 - I/O15 are active and controlled by  $\overline{CE}$  and  $\overline{OE}$ .

If the  $\overline{\text{BYTE}}$  pin is set at logic "0", the device is in byte configuration, and only data I/O pins I/O0 - I/O7 are active and controlled by  $\overline{\text{CE}}$  and  $\overline{\text{OE}}$ . The data I/O pins I/O8 - I/O14 are tri-stated and the I/O15 pin is used as an input for the LSB (A-1) address function.

### AT49F004(T) Block Diagram



### AT49F4096A(T) Block Diagram



### **Device Operation**

**READ:** The AT49F004(T)/4096A(T) is accessed like an EPROM. When  $\overline{CE}$  and  $\overline{OE}$  are low and  $\overline{WE}$  is high, the data stored at the memory location determined by the address pins is asserted on the outputs. The outputs are put in the high impedance state whenever  $\overline{CE}$  or  $\overline{OE}$  is high. This dual-line control gives designers flexibility in preventing bus contention.

**COMMAND SEQUENCES:** When the device is first powered on it will be reset to the read or standby mode depending upon the state of the control line inputs. In order to perform other device functions, a series of command sequences are entered into the device. The command

sequences are shown in the Command Definitions table (I/O8 - I/O15 are don't care inputs for the command codes). The command sequences are written by applying a low pulse on the  $\overline{\text{WE}}$  or  $\overline{\text{CE}}$  input with  $\overline{\text{CE}}$  or  $\overline{\text{WE}}$  low (respectively) and  $\overline{\text{OE}}$  high. The address is latched on the falling edge of  $\overline{\text{CE}}$  or  $\overline{\text{WE}}$ , whichever occurs last. The data is latched by the first rising edge of  $\overline{\text{CE}}$  or  $\overline{\text{WE}}$ . Standard microprocessor write timings are used. The address locations used in the command sequences are not affected by entering the command sequences.

**RESET:** A RESET input pin is provided to ease some system applications. When RESET is at a logic high level, the





device is in its standard operating mode. A low level on the  $\overline{\text{RESET}}$  input halts the present device operation and puts the outputs of the device in a high impedance state. When a high level is reasserted on the  $\overline{\text{RESET}}$  pin, the device returns to the Read or Standby mode, depending upon the state of the control inputs. By applying a 12V  $\pm$  0.5V input signal to the  $\overline{\text{RESET}}$  pin the boot block array can be reprogrammed even if the boot block program lockout feature has been enabled (see Boot Block Programming Lockout Override section).

**ERASURE:** Before a byte or word can be reprogrammed, it must be erased. The erased state of memory bits is a logical "1". The entire device can be erased by using the Chip Erase command or individual sectors can be erased by using the Sector Erase commands.

**CHIP ERASE:** The entire device can be erased at one time by using the 6-byte chip erase software code. After the chip erase has been initiated, the device will internally time the erase operation so that no external clocks are required. The maximum time to erase the chip is  $t_{\rm EC}$ .

If the boot block lockout has been enabled, the Chip Erase will not erase the data in the boot block; it will erase the main memory block and the parameter blocks only. After the chip erase, the device will return to the read or standby mode.

**SECTOR ERASE:** As an alternative to a full chip erase, the device is organized into four sectors that can be individually erased. There are two 4K word parameter block sections, one boot block, and the main memory array block. The Sector Erase command is a six bus cycle operation. The sector address is latched on the falling WE edge of the sixth cycle while the 30H data input command is latched at the rising edge of WE. The sector erase starts after the rising edge of  $\overline{WE}$  of the sixth cycle. The erase operation is internally controlled; it will automatically time to completion. Whenever the main memory block is erased and reprogrammed, the two parameter blocks should be erased and reprogrammed before the main memory block is erased again. Whenever a parameter block is erased and reprogrammed, the other parameter block should be erased and reprogrammed before the first parameter block is erased again. Whenever the boot block is erased and reprogrammed, the main memory block and the parameter blocks should be erased and reprogrammed before the boot block is erased again.

**BYTE/WORD PROGRAMMING:** Once a memory block is erased, it is programmed (to a logical "0") on a byte-by-byte or word-by-word basis. Programming is accomplished via the internal device command register and is a 4 bus cycle operation. The device will automatically generate the required internal program pulses.

Any commands written to the chip during the embedded programming cycle will be ignored. If a hardware reset hap-

pens during programming, the data at the location being programmed will be corrupted. Please note that a data "0" cannot be programmed back to a "1"; only erase operations can convert "0"s to "1"s. Programming is completed after the specified  $t_{\rm BP}$  cycle time. The DATA polling feature may also be used to indicate the end of a program cycle.

BOOT BLOCK PROGRAMMING LOCKOUT: The device has one designated block that has a programming lockout feature. This feature prevents programming of data in the designated block once the feature has been enabled. The size of the block is 8K words. This block, referred to as the boot block, can contain secure code that is used to bring up the system. Enabling the lockout feature will allow the boot code to stay in the device while data in the rest of the device is updated. This feature does not have to be activated; the boot block's usage as a write protected region is optional to the user. The address range of the boot block is 00000H to 03FFFH for the AT49F004T; 00000H to 01FFFH for the AT49F4096AT.

Once the feature is enabled, the data in the boot block can no longer be erased or programmed when input levels of 5.5V or less are used. Data in the main memory block can still be changed through the regular programming method. To activate the lockout feature, a series of six program commands to specific addresses with specific data must be performed. Please refer to the Command Definitions table.

method is available to determine if programming of the boot block section is locked out. When the device is in the software product identification mode (see Software Product Identification Entry and Exit sections) a read from the following address location will show if programming the boot block is locked out—00002H for AT49F004 and AT49F4096A; 7C002 for the AT49F004T; and 3E002H for the AT49F4096AT. If the data on I/O0 is low, the boot block can be programmed; if the data on I/O0 is high, the program lockout feature has been enabled and the block cannot be programmed. The software product identification exit code should be used to return to standard operation.

#### **BOOT BLOCK PROGRAMMING LOCKOUT OVERRIDE:**

The user can override the boot block programming lockout by taking the RESET pin to 12 volts during the entire chip erase, sector erase or word programming operation. When the RESET pin is brought back to TTL levels the boot block programming lockout feature is again active.

**PRODUCT IDENTIFICATION:** The product identification mode identifies the device and manufacturer as Atmel. It may be accessed by hardware or software operation. The hardware operation mode can be used by an external programmer to identify the correct programming algorithm for the Atmel product.

## AT49F004(T)/4096A(T)

For details, see Operating Modes (for hardware operation) or Software Product Identification. The manufacturer and device code is the same for both modes.

DATA POLLING: The AT49F004(T)/4096A(T) features DATA polling to indicate the end of a program cycle. During a program cycle an attempted read of the last byte loaded will result in the complement of the loaded data on I/O7. Once the program cycle has been completed, true data is valid on all outputs and the next cycle may begin. During a chip or sector erase operation, an attempt to read the device will give a "0" on I/O7. Once the program or erase cycle has completed, true data will be read from the device. DATA polling may begin at any time during the program cycle.

TOGGLE BIT: In addition to DATA polling the AT49F004(T)/4096A(T) provides another method for determining the end of a program or erase cycle. During a program or erase operation, successive attempts to read data from the device will result in I/O6 toggling between one and zero. Once the program cycle has completed, I/O6 will stop

toggling and valid data will be read. Examining the toggle bit may begin at any time during a program cycle.

READY/BUSY: For the AT49F004(T), pin 12 is an open drain READY/BUSY output pin which provides another method of detecting the end of a program or erase operation. RDY/BUSY is actively pulled low during the internal program and erase cycles and it is released at the completion of the cycle. The open drain connection allows for ORtying of several devices to the same RDY/BUSY line.

**HARDWARE DATA PROTECTION:** Hardware features protect against inadvertent programs to the AT49F004(T)/4096A(T) in the following ways: (a)  $V_{CC}$  sense: if  $V_{CC}$  is below 3.8V (typical), the program function is inhibited. (b)  $V_{CC}$  power on delay: once  $V_{CC}$  has reached the  $V_{CC}$  sense level, the device will automatically time out 10 ms (typical) before programming. (c) Program inhibit: holding any one of  $\overline{OE}$  low,  $\overline{CE}$  high or  $\overline{WE}$  high inhibits program cycles. (d) Noise filter: pulses of less than 15 ns (typical) on the  $\overline{WE}$  or  $\overline{CE}$  inputs will not initiate a program cycle.





### **Command Definition (in Hex)**<sup>(1)</sup>

Command	Bus	1st Bus 2nd Bus Cycle Cycle			3rd Bus Cycle		4th Bus Cycle		5th Bus Cycle		6th Bus Cycle		
Sequence	Cycles	Addr	Data	Addr	Data	Addr	Data	Addr	Data	Addr	Data	Addr	Data
Read	1	Addr	D <sub>OUT</sub>										
Chip Erase	6	5555	AA	2AAA	55	5555	80	5555	AA	2AAA	55	5555	10
Sector Erase	6	5555	AA	2AAA	55	5555	80	5555	AA	2AAA	55	SA <sup>(4)</sup>	30
Byte/Word Program	4	5555	AA	2AAA	55	5555	A0	Addr	D <sub>IN</sub>				
Boot Block Lockout <sup>(2)</sup>	6	5555	AA	2AAA	55	5555	80	5555	AA	2AAA	55	5555	40
Product ID Entry	3	5555	AA	2AAA	55	5555	90						
Product ID Exit <sup>(3)</sup>	3	5555	AA	2AAA	55	5555	F0						
Product ID Exit <sup>(3)</sup>	1	xxxx	F0										

Notes: 1. The DATA FORMAT in each bus cycle is as follows: I/O15 - I/O8 (Don't Care); I/O7 - I/O0 (Hex)
The ADDRESS FORMAT in each bus cycle is as follows: A15 - A0 (Hex), A-1, and A15 - A18 (Don't Care)

- 2. The boot sector has the address range 00000H to 03FFFH for the AT49F004; 7C000H to 7FFFFH for the AT49F004T; 00000H to 01FFFH for the AT49F4096A; and 3E000H to 3FFFFH for the AT49F4096AT.
- 3. Either one of the Product ID Exit commands can be used.

4. SA = sector addresses: (A18 - A0)

For the AT49F004

SA = 03XXX for BOOT BLOCK

SA = 05XXX for PARAMETER BLOCK 1 SA = 07XXX for PARAMETER BLOCK 2 SA = 7FXXX for MAIN MEMORY ARRAY

For the AT49F004(T)

SA = 7FXXX for BOOT BLOCK

SA = 7BXXX for PARAMETER BLOCK 1 SA = 79XXX for PARAMETER BLOCK 2 SA = 77XXX for MAIN MEMORY ARRAY SA = sector addresses: (A17 - A0)

For the AT49F4096A

SA = 01XXX for BOOT BLOCK

SA = 02XXX for PARAMETER BLOCK 1 SA = 03XXX for PARAMETER BLOCK 2 SA = 3FXXX for MAIN MEMORY ARRAY

For the AT49F4096AT

SA = 3FXXX for BOOT BLOCK

SA = 3DXXX for PARAMETER BLOCK 1 SA = 3CXXX for PARAMETER BLOCK 2 SA = 3BXXX for MAIN MEMORY ARRAY

### **Absolute Maximum Ratings\***

Temperature Under Bias55°C to +125°C
Storage Temperature65°C to +150°C
All Input Voltages (including NC Pins) with Respect to Ground0.6V to +6.25V
All Output Voltages with Respect to Ground0.6V to V <sub>CC</sub> + 0.6V
Voltage on RESET with Respect to Ground0.6V to +13.5V

\*NOTICE:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **DC and AC Operating Range**

		AT49F004(T)/4096A(T)-55	AT49F004(T)/4096A(T)-70	AT49F004(T)/4096A(T)-90	
Operating	Com.	0°C - 70°C	0°C - 70°C	0°C - 70°C	
Temperature (Case)	Ind.	N/A	-40°C - 85°C	-40°C - 85°C	
V <sub>CC</sub> Power Supply		5V ± 10%	5V ± 10%	5V ± 10%	

### **Operating Modes**

Mode	CE	ŌĒ	WE	RESET	Ai	I/O
Read	$V_{IL}$	$V_{IL}$	V <sub>IH</sub>	V <sub>IH</sub>	Ai	D <sub>OUT</sub>
Program/Erase <sup>(2)</sup>	V <sub>IL</sub>	V <sub>IH</sub>	V <sub>IL</sub>	V <sub>IH</sub>	Ai	D <sub>IN</sub>
Standby/Program Inhibit	$V_{IH}$	X <sup>(1)</sup>	Х	V <sub>IH</sub>	Х	High Z
Program Inhibit	Х	Х	V <sub>IH</sub>	V <sub>IH</sub>		
Program Inhibit	Х	$V_{IL}$	Х	V <sub>IH</sub>		
Output Disable	Х	$V_{IH}$	Х	V <sub>IH</sub>		High Z
Reset	Х	Х	Х	V <sub>IL</sub>	Х	High Z
Product Identification						
Handran	.,		.,,	.,,	A1 - A18 = V <sub>IL</sub> , A9 = V <sub>H</sub> , (3) A0 = V <sub>IL</sub>	Manufacturer Code <sup>(4)</sup>
Hardware	$V_{IL}$	$V_{IL}$	V <sub>IH</sub>	V <sub>IH</sub>	A1 - A18 = $V_{IL}$ , A9 = $V_{H}$ , (3) A0 = $V_{IH}$	Device Code <sup>(4)</sup>
C-#(5)					A0 = V <sub>IL</sub> , A1 - A18 = V <sub>IL</sub>	Manufacturer Code <sup>(4)</sup>
Software <sup>(5)</sup>				V <sub>IH</sub>	A0 = V <sub>IH</sub> , A1 - A18 = V <sub>IL</sub>	Device Code <sup>(4)</sup>

Notes: 1. X can be  $V_{IL}$  or  $V_{IH}$ .

2. Refer to AC Programming Waveforms.

3.  $V_H = 12.0V \pm 0.5V$ .

4. Manufacturer Code: 161FH

Device Code: 11H (AT49F004), 1692H (AT49F4096A), 10H (AT49F004T), 1690H (AT49F4096AT).

5. See details under Software Product Identification Entry/Exit.

### **DC Characteristics**

Symbol	Parameter	Condition	Min	Max	Units
I <sub>LI</sub>	Input Load Current	$V_{IN} = 0V \text{ to } V_{CC}$		10	μΑ
I <sub>LO</sub>	Output Leakage Current	$V_{I/O} = 0V \text{ to } V_{CC}$		10	μΑ
I <sub>SB1</sub>	V <sub>CC</sub> Standby Current CMOS	$\overline{\text{CE}}$ = V <sub>CC</sub> - 0.3V to V <sub>CC</sub>		300	μΑ
I <sub>SB2</sub>	V <sub>CC</sub> Standby Current TTL	$\overline{\text{CE}}$ = 2.0V to V <sub>CC</sub>		3	mA
I <sub>CC</sub> <sup>(1)</sup>	V <sub>CC</sub> Active Current	f = 5 MHz; I <sub>OUT</sub> = 0 mA		50	mA
V <sub>IL</sub>	Input Low Voltage			0.8	V
V <sub>IH</sub>	Input High Voltage		2.0		V
V <sub>OL</sub>	Output Low Voltage	I <sub>OL</sub> = 2.1 mA		0.45	V
V <sub>OH</sub>	Output High Voltage	I <sub>OH</sub> = -400 μA	2.4		V

Note: 1. In the erase mode, I<sub>CC</sub> is 90 mA.

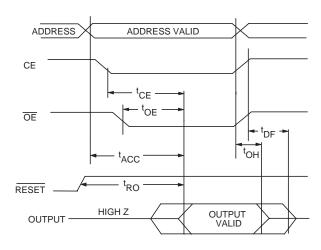




#### **AC Read Characteristics**

		AT49F004(T)/4096A(T)-55		AT49F004(T)/4096A(T)-70		AT49F004(T)/4096A(T)-90		
Symbol	Parameter	Min	Max	Min	Max	Min	Max	Units
t <sub>ACC</sub>	Address to Output Delay		55		70		90	ns
t <sub>CE</sub> <sup>(1)</sup>	CE to Output Delay		55		70		90	ns
t <sub>OE</sub> <sup>(2)</sup>	OE to Output Delay	0	30	0	35	0	40	ns
t <sub>DF</sub> <sup>(3)(4)</sup>	CE or OE to Output Float	0	25	0	25	0	25	ns
t <sub>OH</sub>	Output Hold from OE, CE or Address, whichever occurred first	0		0		0		ns
t <sub>RO</sub>	RESET to Output Delay		800		800		800	ns

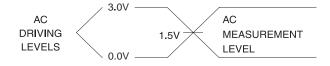
### AC Read Waveforms<sup>(1)(2)(3)(4)</sup>



Notes: 1.  $\overline{CE}$  may be delayed up to  $t_{ACC}$  -  $t_{CE}$  after the address transition without impact on  $t_{ACC}$ .

- $\overline{\text{OE}}$  may be delayed up to  $t_{\text{CE}}$   $t_{\text{OE}}$  after the falling edge of  $\overline{\text{CE}}$  without impact on  $t_{\text{CE}}$  or by  $t_{\text{ACC}}$   $t_{\text{OE}}$  after an address change without impact on  $t_{ACC}$ .
- 3.  $t_{DF}$  is specified from  $\overline{OE}$  or  $\overline{CE}$  whichever occurs first ( $C_L = 5 \text{ pF}$ ).
- 4. This parameter is characterized and is not 100% tested.

### Input Test Waveforms and Measurement Level



 $t_R$ ,  $t_F < 5$  ns

### **Pin Capacitance**

 $f = 1 \text{ MHz}, T = 25^{\circ}C^{(1)}$ 

<u>5.0</u> V	<u>5.0</u> V
1.8K <	1.8K <
OUTPUT	OUTPUT
PIN	PIN
	1 0K = 100 pF

90 ns

**Output Test Load** 

55/70 ns

	Тур	Max	Units	Conditions
C <sub>IN</sub>	4	6	pF	V <sub>IN</sub> = 0V
C <sub>OUT</sub>	8	12	pF	V <sub>OUT</sub> = 0V

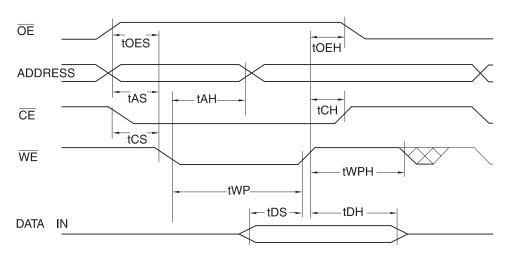
Note: 1. This parameter is characterized and is not 100% tested.

AT49F004(T)/4096A(T)

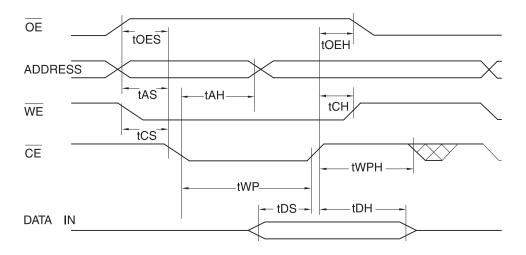
### **AC Word Load Characteristics**

Symbol	Parameter	Min	Max	Units
t <sub>AS</sub> , t <sub>OES</sub>	Address, OE Set-up Time	10		ns
t <sub>AH</sub>	Address Hold Time	100		ns
t <sub>CS</sub>	Chip Select Set-up Time	0		ns
t <sub>CH</sub>	Chip Select Hold Time	0		ns
t <sub>WP</sub>	Write Pulse Width (WE or CE)	100		ns
t <sub>DS</sub>	Data Set-up Time	100		ns
t <sub>DH</sub> , t <sub>OEH</sub>	Data, OE Hold Time	10		ns
t <sub>WPH</sub>	Write Pulse Width High	50		ns

# AC Byte/Word Load Waveforms WE Controlled



#### **CE** Controlled



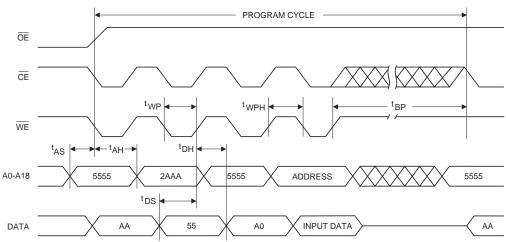




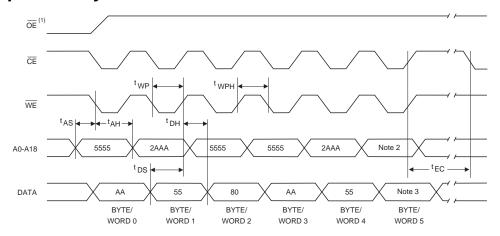
### **Program Cycle Characteristics**

Symbol	Parameter	Min	Тур	Max	Units
t <sub>BP</sub>	Byte/Word Programming Time		10	50	μs
t <sub>AS</sub>	Address Set-up Time	0			ns
t <sub>AH</sub>	Address Hold Time	100			ns
t <sub>DS</sub>	Data Set-up Time	100			ns
t <sub>DH</sub>	Data Hold Time	0			ns
t <sub>WP</sub>	Write Pulse Width	100			ns
t <sub>WPH</sub>	Write Pulse Width High	50			ns
t <sub>EC</sub>	Erase Cycle Time			10	seconds

### **Program Cycle Waveforms**



### **Sector or Chip Erase Cycle Waveforms**



- Notes: 1.  $\overline{OE}$  must be high only when  $\overline{WE}$  and  $\overline{CE}$  are both low.
  - 2. For chip erase, the address should be 5555. For sector erase, the address depends on what sector is to be erased. (See note 4 under command definitions.)
  - 3. For chip erase, the data should be 10H, and for sector erase, the data should be 30H.

## 10 AT49F004(T)/4096A(T)

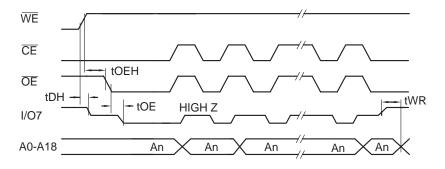
### **Data Polling Characteristics**(1)

Symbol	Parameter	Min	Тур	Max	Units
t <sub>DH</sub>	Data Hold Time	10			ns
t <sub>OEH</sub>	OE Hold Time	10			ns
t <sub>OE</sub>	OE to Output Delay <sup>(2)</sup>				ns
t <sub>WR</sub>	Write Recovery Time	0			ns

Notes: 1. These parameters are characterized and not 100% tested.

2. See  $t_{OE}$  spec in AC Read Characteristics.

### **Data Polling Waveforms**



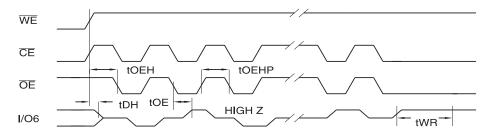
### Toggle Bit Characteristics(1)

Symbol	Parameter	Min	Тур	Max	Units
t <sub>DH</sub>	Data Hold Time	10			ns
t <sub>OEH</sub>	OE Hold Time	10			ns
t <sub>OE</sub>	OE to Output Delay <sup>(2)</sup>				ns
t <sub>OEHP</sub>	OE High Pulse	150			ns
t <sub>WR</sub>	Write Recovery Time	0			ns

Notes: 1. These parameters are characterized and not 100% tested.

2. See t<sub>OE</sub> spec in AC Read Characteristics.

### Toggle Bit Waveforms<sup>(1)(2)(3)</sup>



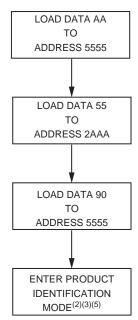
Notes: 1. Toggling either  $\overline{OE}$  or  $\overline{CE}$  or both  $\overline{OE}$  and  $\overline{CE}$  will operate toggle bit. The t<sub>OEHP</sub> specification must be met by the toggling input(s).

- 2. Beginning and ending state of I/O6 will vary.
- 3. Any address location may be used but the address should not vary.

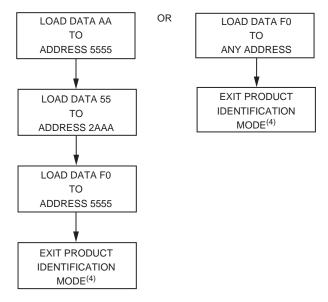




### **Software Product Identification Entry**(1)



### **Software Product Identification Exit**(1)(6)



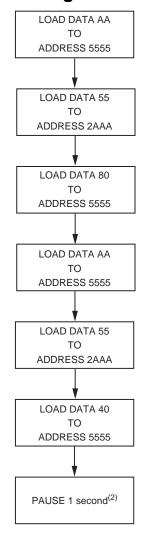
Notes:

- Data Format: I/O15 I/O8 (Don't Care); I/O7 I/O0 (Hex) Address Format: A15 - A0 (Hex), A-1, and A15 - A18 (Don't Care).
- 2. A1 A18 =  $V_{IL}$ .

Manufacture Code is read for  $A0 = V_{IL}$ ; Device Code is read for  $A0 = V_{IH}$ .

- The device does not remain in identification mode if powered down.
- 4. The device returns to standard operation mode.
- Manufacturer Code: 161FH
   Device Code: 11H (AT49F004), 1692H (AT49F4096A), 1692H (AT49F004T), 1690H (AT49F4096AT)
- 6. Either one of the Product ID Exit commands can be used.

### Boot Block Lockout Enable Algorithm<sup>(1)</sup>



Notes:

- Data Format: I/O15 I/O8 (Don't Care); I/O7 I/O0 (Hex) Address Format: A15 - A0 (Hex), A-1, and A15 - A18 (Don't Care).
- Boot block lockout feature enabled.

## AT49F004(T) Ordering Information

t <sub>ACC</sub>	I <sub>CC</sub> (mA)					
(ns)	Active	Standby	Ordering Code	Package	Operation Range	
55	50	0.3	AT49F004-55TC	40T	Commercial (0° to 70°C)	
70	50	0.3	AT49F004-70TC	40T	Commercial (0° to 70°C)	
			AT49F004-70TI	40T	Industrial (-40° to 85°C)	
90	50	0.3	AT49F004-90TC	40T	Commercial (0° to 70°C)	
			AT49F004-90TI	40T	Industrial (-40° to 85°C)	
55	50	0.3	AT49F004T-55TC	40T	Commercial (0° to 70°C)	
70	50	0.3	AT49F004T-70TC	40T	Commercial (0° to 70°C)	
			AT49F004T-70TI	40T	Industrial (-40° to 85°C)	
90	50	0.3	AT49F004T-90TC	40T	Commercial (0° to 70°C)	
			AT49F004T-90TI	40T	Industrial (-40° to 85°C)	

Package Type				
40T	40-Lead, Plastic Thin Small Outline Package (TSOP)			





## AT49F4096A(T) Ordering Information

t <sub>ACC</sub>	I <sub>CC</sub> (mA)				
(ns)	Active	Standby	Ordering Code	Package	Operation Range
55	50	0.3	AT49F4096A-55RC	44R	Commercial
			AT49F4096A-55TC	48T	(0° to 70°C)
70	50	50 0.3	AT49F4096A-70RC	44R	Commercial
			AT49F4096A-70TC	48T	(0° to 70°C)
			AT49F4096A-70RI	44R	Industrial
			AT49F4096A-70TI	48T	(-40° to 85°C)
90	50	0 0.3	AT49F4096A-90RC	44R	Commercial
			AT49F4096A-90TC	48T	(0° to 70°C)
			AT49F4096A-90RI	44R	Industrial
			AT49F4096A-90TI	48T	(-40° to 85°C)
55	50	0.3	AT49F4096AT-55RC	44R	Commercial
			AT49F4096AT-55TC	48T	(0° to 70°C)
70	50	0.3	AT49F4096AT-70RC	44R	Commercial
			AT49F4096AT-70TC	48T	(0° to 70°C)
			AT49F4096AT-70RI	44R	Industrial
			AT49F4096AT-70TI	48T	(-40° to 85°C)
90	50	0.3	AT49F4096AT-90RC	44R	Commercial
			AT49F4096AT-90TC	48T	(0° to 70°C)
			AT49F4096AT-90RI	44R	Industrial
			AT49F4096AT-90TI	48T	(-40° to 85°C)

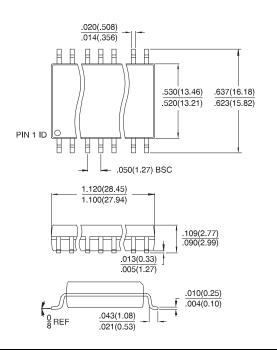
Package Type				
44R	44-Lead, 0.525" Wide, Plastic Gull Wing Small Outline (SOIC)			
48T	48-Lead, Plastic Thin Small Outline Package (TSOP)			

# AT49F004(T)/4096A(T)

### **Packaging Information**

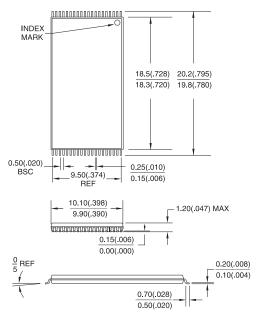
44R, 44-Lead, 0.525" Wide, Plastic Gull Wing Small Outline (SOIC)

Dimensions in Inches and (Millimeters)



40T, 40-Lead, Plastic Thin Small Outline Package (TSOP)

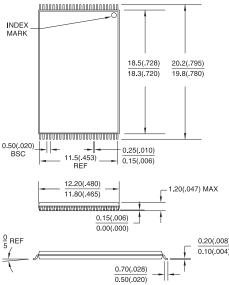
Dimensions in Inches and (Millimeters)



\*Controlling dimension: millimeters

#### 48T, 48-Lead, Plastic Thin Small Outline Package (TSOP)

Dimensions in Millimeters and (Inches)\* JEDEC OUTLINE MO-142 D



\*Controlling dimension: millimeters

